





Revision History			
Date	Revision	Change description	Changed By
10/02/2012	1.0	Initial Design	P. R.
08/05/2012	1.1	Changes to the layout	P. R.

BUILD STATISTICS

GENERAL	
NETS	23
COMPONENTS	36
PRIMITIVES	
FILLS	2
TRACKS	1288
STRINGS	102
ARCS	13
LANDS	
PADS	114
VIA'S	31
HOLES (Total)	37
PRINT SCALE	
SCALE: 1.00	

Layer Stack Up Detail for:  
FT230XQ\_GPS\_Dongle.pcbdoc

Layer  
Name

- [1] Top Layer
- [2] Ground Plane
- [3] Power Plane
- [4] Bottom Layer

TITLE: **FT230XQ GPS Dongle**

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ENGINEER:	P. R.	DATE:	27/06/2012
PCB DESIGNER:	P. R.	FILE NAME:	FT230XQ_GPS_Dongle.pcbdoc

Future Technology Devices International Ltd.  
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PART No.:	*	REV:	1.0
DWG No.:	HW_248	SCALE:	SCALE: 1.00

A4

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ENGINEER: P. R.

PCB DESIGNER: P. R.

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